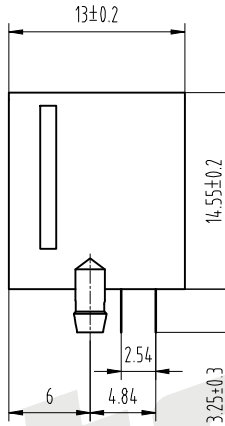
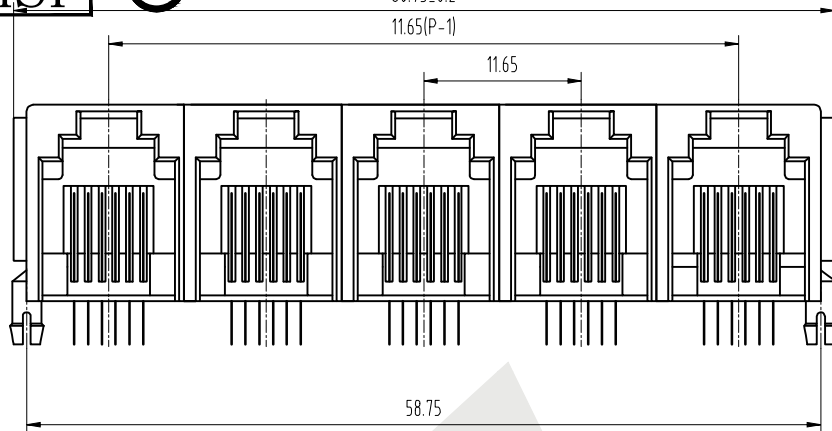


HSF



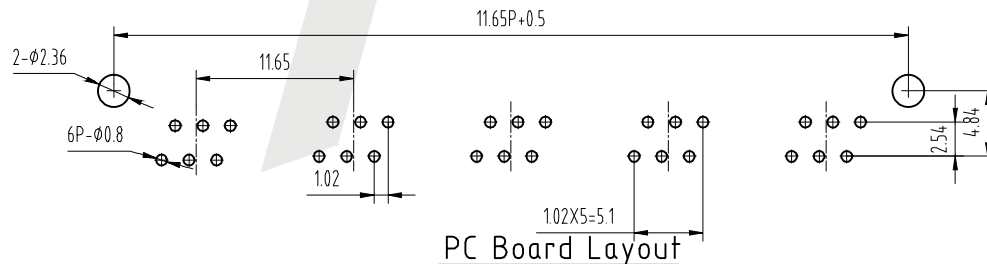
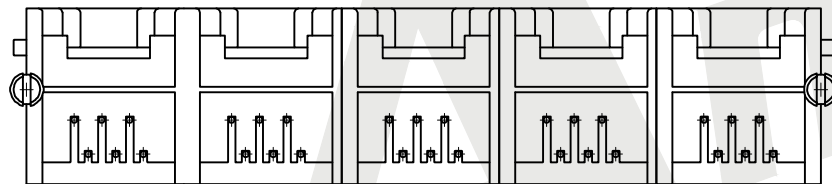
60.75±0.2
11.65(P-1)



- NOTES:
MATERIAL:
1. HOUSING MATERIAL :GLASS FILLED POYESTER UL94V-0.
2. CONTACT MATERIAL :PHOSPHOR BRONZE $\tau=0.3\text{mm}$
3. PLATING :SELECTING GOLD PLATING $1\mu\sim 50\mu$ OVER
NICKEL IN CONTACT AREA. 150μ TIN
PLATIN. OVER NICKEL IN SOLDER AREA
4. SHIELD :0.2mm THICKNESS COPPER WITH NICKEL PLATEI
- ELECTRICAL
1. VOLTAGE RATING :125VAC RMS
2. CURRENT RATING :1.5AMP
3. CONTACT RESISTANCE:30MILLIOHMS MAX
4. INSULATION RESISTANCE 500MEG OHMS MIN @500V DC
5. DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN
- MECHANICAL
1. DURRABILITY :750 CYCLES MIN
2. PCB RETENTTON PRB-SOLDER :1 LB MIN
- REVISIONAL
1. STORAGE : -40° C TO 85° C
2. OPERATION :0° C TO 70° C

Order code:

ATRJ5522 — 6P — 6C — X — A — D — A
① ② ③ ④ ⑤ ⑥ ⑦



PC Board Layout
Component Side Shown

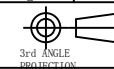
- ① SERIES NO:
② NUMBER OF POSITIONS (8P,6P,4P)
③ NUMBER OF CONTACTS (8C, 6C, 4C)
④ Contact Plating
G0:Gold flash
G1: 3U" Gold
G2: 5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
SN: Tin
- ⑤ Shield
A:W/O Shield
B:Half Shield
C:Shield W/Eml
D:Shield W/O Eml
- ⑥ Ports
A:1X1P
B:1X2P
C:1X4P
D:1X5P
E:1X6P
F:1X8P
- ⑦ With Panel or not
A:With panel
B:Without panel

Unless Otherwise specified tolerance
X. ±0.35 X.XX:±0.20
X.X:±0.25 X.XXX:±0.15

Antenk ANTENK ELECTRONICS CO.,LTD
Http://www.antenk.com
E-mail:sales@antenk.com

SCALE: As Shown UNIT: mm
DRAW Wu Sai DATE 22/03/2018
CHECK BobYang DATE 22/03/2018

TITLE: RJ11 Jack side entry,
Full Plastic, 1X5P with Panel



DRAWING NO: ATRJ5522-6P6C-X-A-D-A
PRODUCT NO: ATRJ5522-6P6C-X-A-D-A

D

D

REV	DESCRIPTION	DATE
1		
2		
3		
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